

STPS5L25

Low drop power Schottky rectifier

Datasheet – production data

Description

Single Schottky rectifier suited for switch mode power supply and high frequency DC to DC converters.

Packaged in DPAK, this device is intended for use as a rectifier at the secondary of 3.3 V SMPS units.

Symbol	Value		
I _{F(AV)}	5 A		
V _{RRM}	25 V		
T _{j (max)}	150 °C		
V _{F(typ)}	0.31 V		

Table 1. Device summary

Features

- Very low forward voltage drop for less power dissipation and reduced heatsink
- Optimized conduction/reverse losses trade-off which means the highest efficiency in the applications
- High power surface mount miniature package
- Avalanche specification
- ECOPACK[®]2 compliant component for DPAK on demand

1 Characteristics

Table 2. Absolute ratings (limiting values, at 25 °C unless otherwise stated)

Symbol	Parameter	Value	Unit	
V _{RRM}	Repetitive peak reverse voltage	25	V	
I _{F(RMS)}	Forward rms current	7	А	
I _{F(AV)}	Average forward current, δ = 0.5 square wave	5	Α	
I _{FSM}	Surge non repetitive forward current	75	Α	
P _{ARM}	Repetitive peak avalanche power	215	W	
T _{stg}	Storage temperature range	-65 to +150	°C	
Тj	Maximum operating junction temperature ⁽¹⁾	150	°C	
dPtot	1			

1. $\frac{dPtot}{dT_j} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal resistance

Symbol	Parameter	Max. value	Unit	
R _{th(j-c)}	Junction to case	2.5	°C/W	

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾	Reverse leakage current	T _j = 25 °C	V _R = V _{RRM}	-	-	350	μA
		T _j = 125 °C		-	55	115	mA
	Forward voltage drop	T _j = 25 °C	I _F = 5 A	-	-	0.47	V
V _F ⁽¹⁾		T _j = 125 °C		-	0.31	0.35	
VE		T _j = 25 °C	I _F = 10 A	-	-	0.59	
		T _j = 125 °C		-	0.41	0.50	

Table 4. Static electrical characteristics

1. Pulse test: $t_p = 380 \ \mu s, \ \delta < 2\%$

To evaluate the conduction losses use the following equation:

 $P = 0.2 \text{ x } I_{F(AV)} + 0.03 \text{ x } I_{F}^{2}(RMS)$





57





2 Package Information

- Epoxy meets UL94,V0
- Cooling method: by conduction (C)

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

2.1 DPAK package information





Note:

This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.



DocID3626 Rev 8

	Dimensions					
Ref.		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
А	2.18		2.40	0.085		0.094
A1	0.90		1.10	0.035		0.043
A2	0.03		0.23	0.001		0.009
b	0.64		0.90	0.025		0.035
b4	4.95		5.46	0.194		0.214
С	0.46		0.61	0.018		0.024
c2	0.46		0.60	0.018		0.023
D	5.97		6.22	0.235		0.244
D1	4.95		5.60	0.194		0.220
E	6.35		6.73	0.250		0.264
E1	4.32		5.50	0.170		0.216
е		2.28			0.090	
e1	4.40		4.70	0.173		0.185
Н	9.35		10.40	0.368		0.409
L	1.00		1.78	0.039		0.070
L2	1		1.27			0.050
L4	0.60		1.02	0.023		0.040
V2	-8°		+8°	-8°		8°

Table 5. DPAK package mechanical data





DocID3626 Rev 8

3 Ordering information

Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS5L25B-TR	STPS5 L25B	DPAK	0.32 g	2500	Tape and reel

4 Revision history

Table 7. Document revision	on historv
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Date	Revision Changes	
Jul-2003	5A	Previous release.
15-Apr-2008	6	Reformatted to current standard. Corrected order code in <i>Table 5</i> .
08-Jan-2015	7	Updated package information and reformatted to current standard.
15-May-2017	8	Updated DPAK package information and reformatted to current standard.



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DocID3626 Rev 8

